

# THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of

TOSHIHIRO NISHII ET AL

Serial No. 10/517,445

Filed: December 9, 2004

Title: Method of manufacturing circuit

forming boards

Office of Initial Patent

Examination's Filing Receipt

Corrections

REQUEST FOR CORRECTED FILING RECEIPT

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Sir:

Enclosed herewith is a copy of the Official Filing Receipt for the above-identified application marked in red indicating corrections to be made thereto.

Accordingly, it is requested that the PTO issue a Corrected Filing Receipt reflecting these corrections.

Respectfully submitted,

TOSHIHIRO NISHII ET AL

By and the Charles R. Watts

Registration No. 33,142

Attorney for Applicants

/eak

WENDEROTH, LIND & PONACK, L.L.P. 2033 K. St., N.W., Suite 800 Washington, D.C. 20006-1021 Telephone (202) 721-8200

June 2, 2005



## MED STATES PATENT AND TRADEMARK OFFICE

UNITED STATES DEPARTMENT OF COMMERCE United States Patent and Trademark Offices Address: COMMISSIONER FOR PATENTS P. D. DE 1450 Alexandra, Viginis 22313-1450

FILING OR 371 APPL NO. ART UNIT FIL FEE REC'D ATTY.DOCKET NO DRAWINGS TOT CLMS IND CLMS (c) DATE 10/517,445 12/09/2004 3726 900 2004-1930A 9 9 3

000513 WENDEROTH, LIND & PONACK, L.L.P. 2033 K STREET N. W. SUITE 800 WASHINGTON, DC 20006-1021



Date Mailed: 05/19/2005

Receipt is acknowledged of this regular Patent Application. It will be considered in its order and you will be notified as to the results of the examination. Be sure to provide the U.S. APPLICATION NUMBER, FILING DATE, NAME OF APPLICANT, and TITLE OF INVENTION when inquiring about this application. Fees transmitted by check or draft are subject to collection. Please verify the accuracy of the data presented on this receipt. If an error is noted on this Filing Receipt, please mail to the Commissioner for Patents P.O. Box 1450 Alexandria Va 22313-1450. Please provide a copy of this Filing Receipt with the changes noted thereon. If you received a "Notice to File Missing Parts" for this application, please submit any corrections to this Filing Receipt with your reply to the Notice. When the USPTO processes the reply to the Notice, the USPTO will generate another Filing Receipt incorporating the requested corrections (if appropriate).

### Applicant(s)

Toshihiro Nishii, Osaka, JAPAN; Yoshihiro Kawakita, Osaka, JAPAN; Kunio Kishimoto, Osaka, JAPAN;

Power of Attorney: The patent practitioners associated with Customer Number 000513.

## Domestic Priority data as claimed by applicant

This application is a 371 of PCT/JP04/06868 05/14/2004

#### **Foreign Applications**

JAPAN 2003-140137 05/19/2003

Projected Publication Date: 08/25/2005

Non-Publication Request: No

Early Publication Request: No

As the page tion.

and specification.

Title

Method of Manufacturing Circuit Forming Board

AGircuit formation substrate manufacturing method and circuit formation substrate material

-029

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